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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc717t-ss

4.3 READING THE EPROM PROGRAM MEMORY

To read a program memory location, the user must write 2 bytes of the address to the PMADRH and PMADRL registers, then set control bit RD (PMCON1<0>). Once the read control bit is set, the Program Memory Read (PMR) controller will use the second instruction cycle after to read the data. This causes the second instruction immediately following the "BSF PMCON1,RD" instruction to be ignored. The data is available, in the very next cycle, in the PMDATH and PMDATL registers; therefore it can be read as 2 bytes in the following instructions. PMDATH and PMDATL registers will hold this value until another Program Memory Read or until it is written to by the user.

Note: The two instructions that follow setting the PMCON1 read bit must be NOPs.

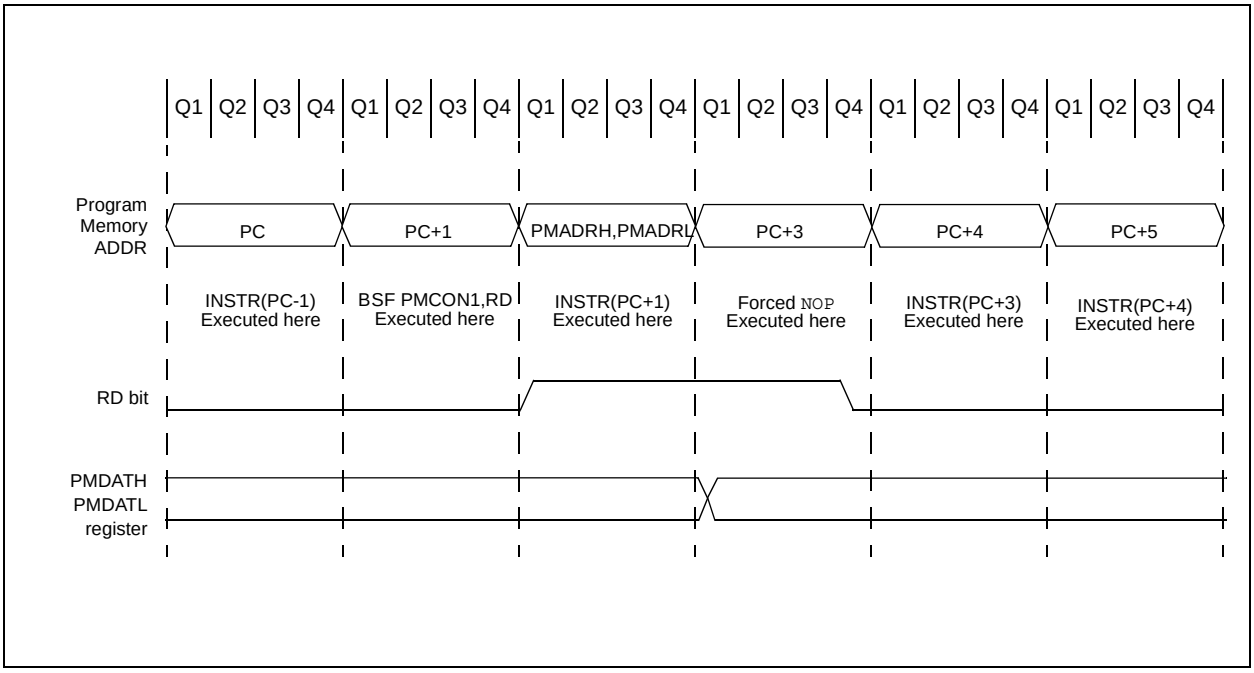
EXAMPLE 4-1: OTP PROGRAM MEMORY Read

```
    BSF     STATUS, RP1      ;
    BCF     STATUS, RP0      ; Bank 2
    MOVLW   MS_PROG_PM_ADDR  ;
    MOVWF   PMADRH           ; MS Byte of Program Memory Address to read
    MOVLW   LS_PROG_PM_ADDR  ;
    MOVWF   PMADRL           ; LS Byte of Program Memory Address to read
    BSF     STATUS, RP0      ; Bank 3
    BSF     PMCON1, RD       ; Program Memory Read
    NOP                      ; This instruction must be an NOP
    NOP                      ; This instruction must be an NOP
    next instruction         ; PMDATH:PMDATL now has the data
```

4.4 OPERATION DURING CODE PROTECT

When the device is code protected, the CPU can still perform the Program Memory Read function.

FIGURE 4-1: PROGRAM MEMORY READ CYCLE EXECUTION



7.0 TIMER2 MODULE

The Timer2 module timer has the following features:

- 8-bit timer (TMR2 register)
- 8-bit period register (PR2)
- Readable and writable (Both registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMR2 match of PR2
- SSP module optional use of TMR2 output to generate clock shift

Timer2 has a control register, shown in Register 7-1. Timer2 can be shut off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

Figure 7-1 is a simplified block diagram of the Timer2 module.

Additional information on timer modules is available in the PIC Mid-Range MCU Family Reference Manual, (DS33023).

7.1 Timer2 Operation

Timer2 can be used as the PWM time-base for PWM mode of the ECCP module.

The TMR2 register is readable and writable, and is cleared on any device RESET.

The input clock (Fosc/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T2CKPS<1:0> (T2CON<1:0>).

The match output of TMR2 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling inclusive) to generate a TMR2 interrupt (latched in flag bit TMR2IF, (PIR1<1>)).

The prescaler and postscaler counters are cleared when any of the following occurs:

- a write to the TMR2 register
- a write to the T2CON register
- any device RESET (Power-on Reset, $\overline{\text{MCLR}}$ Reset, Watchdog Timer Reset, or Brown-out Reset)

TMR2 is not cleared when T2CON is written.

REGISTER 7-1: TIMER2 CONTROL REGISTER (T2CON1: 12h)

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6-3 **TOUTPS<3:0>:** Timer2 Output Postscale Select bits
0000 = 1:1 Postscale
0001 = 1:2 Postscale
•
•
•
1111 = 1:16 Postscale

bit 2 **TMR2ON:** Timer2 On bit
1 = Timer2 is on
0 = Timer2 is off

bit 1-0 **T2CKPS<1:0>:** Timer2 Clock Prescale Select bits
00 = Prescaler is 1
01 = Prescaler is 4
1x = Prescaler is 16

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

8.0 ENHANCED CAPTURE/ COMPARE/PWM (ECCP) MODULES

The ECCP (Enhanced Capture/Compare/PWM) module contains a 16-bit register which can operate as a 16-bit capture register, as a 16-bit compare register or as a PWM master/slave Duty Cycle register. Table 8-1 shows the timer resources of the ECCP module modes.

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON and P1DEL registers control the operation of ECCP. All are readable and writable.

REGISTER 8-1: CCP1 CONTROL REGISTER (CCP1CON: 17h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWM1M1	PWM1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit 7							bit 0

bit 7-6 **PWM1M<1:0>:** PWM Output Configuration

CCP1M<3:2> = 00, 01, 10
xx = P1A assigned as Capture input, Compare output. P1B, P1C, P1D assigned as Port pins.
CCP1M<3:2> = 11
00 = Single output. P1A modulated. P1B, P1C, P1D assigned as Port pins.
01 = Full-bridge output forward. P1D modulated. P1A active. P1B, P1C inactive.
10 = Half-bridge output. P1A, P1B modulated with deadband control. P1C, P1D assigned as Port pins.
11 = Full-bridge output reverse. P1B modulated. P1C active. P1A, P1D inactive.

bit 5-4 **DC1B<1:0>:** PWM Duty Cycle Least Significant bits

Capture Mode: Unused
Compare Mode: Unused
PWM Mode: These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPRnL.

bit 3-0 **CCP1M<3:0>:** ECCP Mode Select bits

0000 = Capture/Compare/PWM off (resets ECCP module)
0001 = Unused (reserved)
0010 = Compare mode, toggle output on match (CCP1IF bit is set)
0011 = Unused (reserved)
0100 = Capture mode, every falling edge
0101 = Capture mode, every rising edge
0110 = Capture mode, every 4th rising edge
0111 = Capture mode, every 16th rising edge
1000 = Compare mode, set output on match (CCP1IF bit is set)
1001 = Compare mode, clear output on match (CCP1IF bit is set)
1010 = Compare mode, generate software interrupt on match (CCP1IF bit is set, CCP1 pin is unaffected)
1011 = Compare mode, trigger special event (CCP1IF bit is set; ECCP resets TMR1, and starts an A/D conversion, if the A/D module is enabled.)
1100 = PWM mode. P1A, P1C active high. P1B, P1D active high.
1101 = PWM mode. P1A, P1C active high. P1B, P1D active low.
1110 = PWM mode. P1A, P1C active low. P1B, P1D active high.
1111 = PWM mode. P1A, P1C active low. P1B, P1D active low.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. Buffer full bit, BF (SSPSTAT<0>), indicates when the SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, bit BF is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the MSSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 9-1 shows the loading of the SSPBUF (SSPSR) for data transmission.

EXAMPLE 9-1: Loading the SSPBUF (SSPSR) Register

```
      BSF   STATUS, RP0    ;Specify Bank 1
LOOP  BTFSS SSPSTAT, BF    ;Has data been
                           ;received
                           ;(xmit complete)?
      GOTO  LOOP           ;No
      BCF   STATUS, RP0    ;Specify Bank 0
      MOVF  SSPBUF, W      ;Save SSPBUF...
      MOVWF RXDATA         ;...in user RAM
      MOVF  TXDATA, W      ;Get next TXDATA
      MOVWF SSPBUF         ;New data to xmit
```

The SSPSR is not directly readable or writable, and can only be accessed by addressing the SSPBUF register. Additionally, the MSSP STATUS register (SSPSTAT) indicates the various status conditions.

9.1.2 ENABLING SPI I/O

To enable the serial port, MSSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON registers, and then set bit SSPEN. This configures the SDI, SDO, SCK and $\overline{SS}$ pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- SDI is automatically controlled by the SPI module
- SDO must have TRISB<5> cleared
- SCK (Master mode) must have TRISB<2> cleared
- SCK (Slave mode) must have TRISB<2> set
- $\overline{SS}$ must have TRISB<1> set, and ANSEL<5> cleared

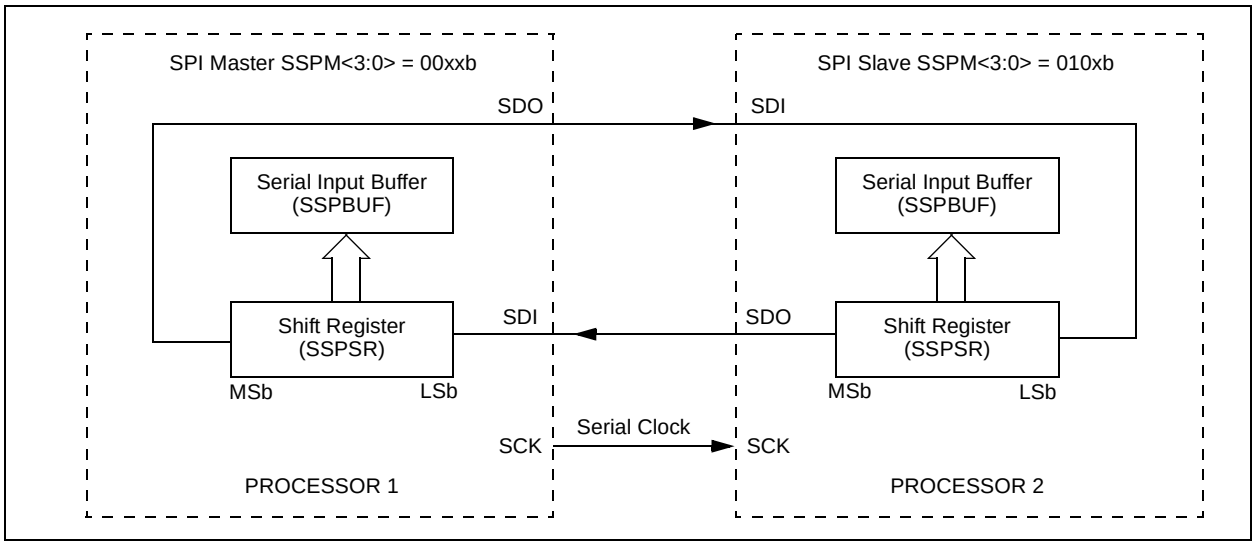
Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

9.1.3 TYPICAL CONNECTION

Figure 9-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to same Clock Polarity (SSPCON<4>), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data — Slave sends dummy data
- Master sends data — Slave sends data
- Master sends dummy data — Slave sends data

FIGURE 9-2: SPI MASTER/SLAVE CONNECTION



9.2.2.3 SLAVE RECEPTION

When the R/$\overline{W}$ bit of the address byte is clear (SSPSR<0> = 0) and an address match occurs, the R/$\overline{W}$ bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register on the falling edge of the eighth SCL pulse.

When the address byte overflow condition exists, then no Acknowledge ($\overline{ACK}$) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) or bit SSPOV (SSPCON<6>) is set.

An MSSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the received byte.

Note:	The SSPBUF will be loaded if the SSPOV bit is set and the BF flag is cleared. If a read of the SSPBUF was performed, but the user did not clear the state of the SSPOV bit before the next receive occurred, the $\overline{ACK}$ is not sent and the SSPBUF is updated.

TABLE 9-2: DATA TRANSFER RECEIVED BYTE ACTIONS

Status Bits as Data Transfer is Received				
BF	**SSPOV**	**SSPSR → SSPBUF**	**Generate $\overline{ACK}$ Pulse**	**Set bit SSPIF (SSP Interrupt occurs if enabled)**
0	0	Yes	Yes	Yes
1	0	No	No	Yes
1	1	No	No	Yes
0	1	Yes	No	Yes

Note 1: Shaded cells show the conditions where the user software did not properly clear the overflow condition.

FIGURE 9-8: I^2C SLAVE MODE WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)

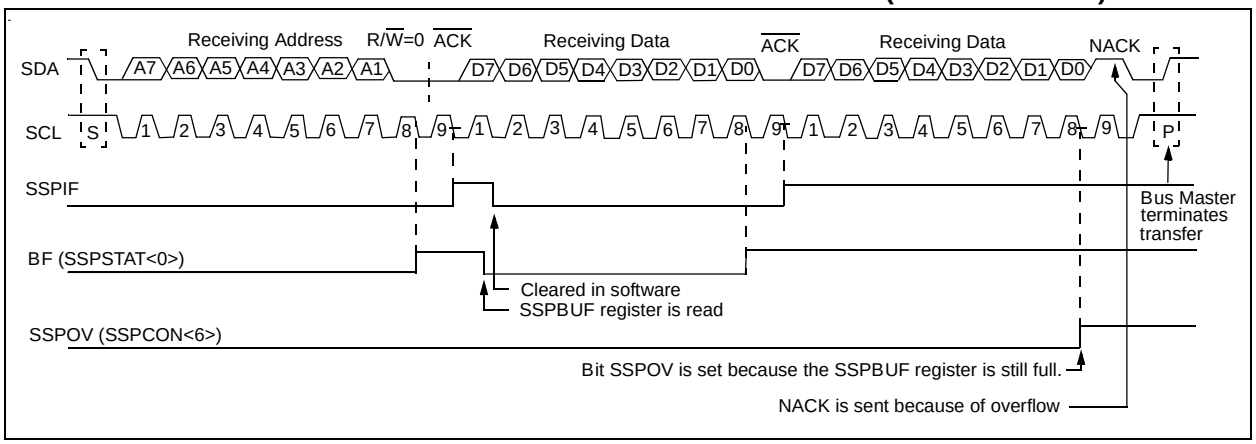
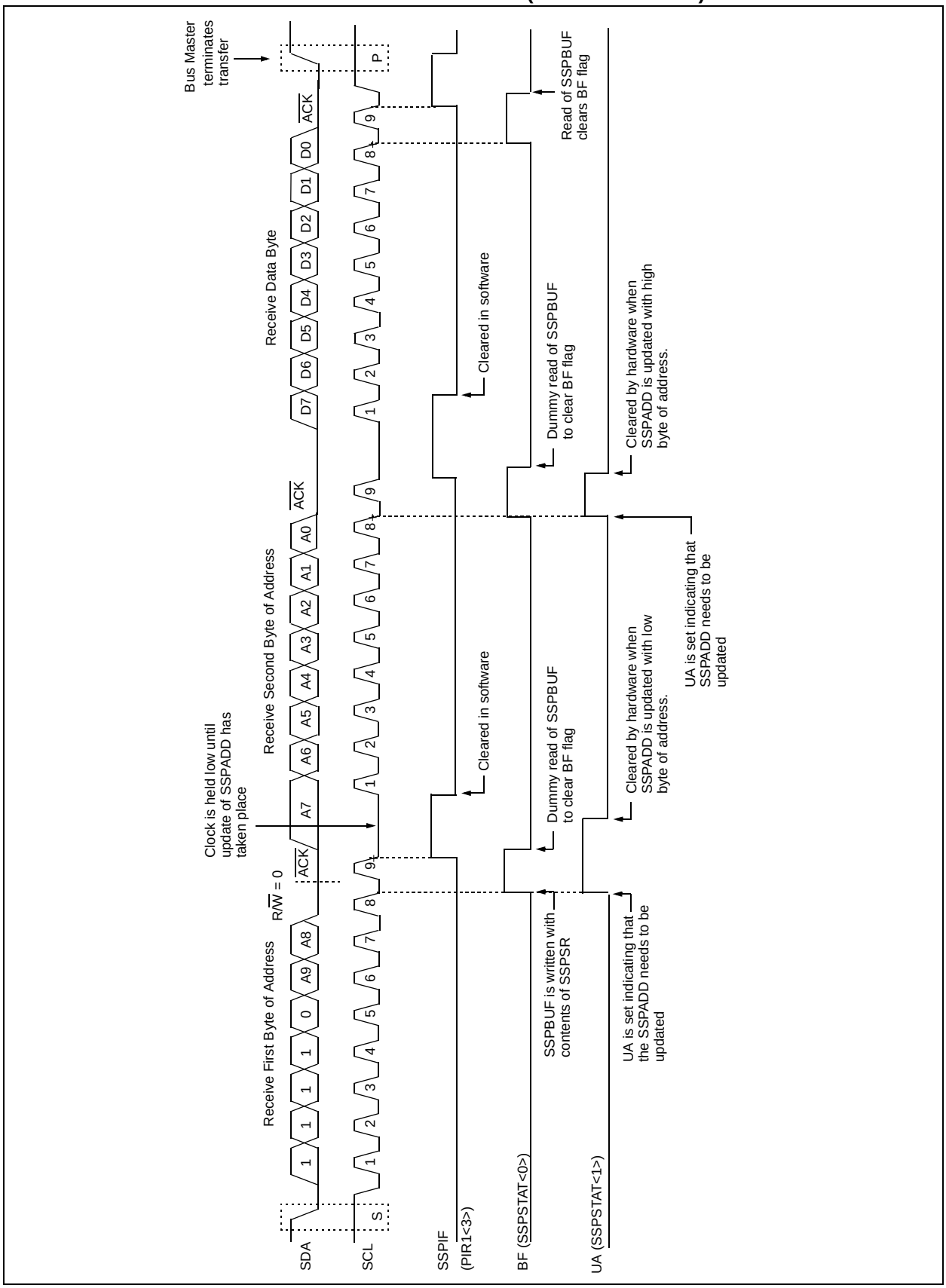


FIGURE 9-9: I²C SLAVE MODE FOR RECEPTION (10-BIT ADDRESS)



9.2.12 I²C MASTER MODE TRANSMISSION

In Master-transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains seven bits of address data and the Read/Write (R/$\overline{W}$) bit. In this case, the R/$\overline{W}$ bit will be logic '0'. Subsequent serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. START and STOP conditions are output to indicate the beginning and the end of a serial transfer.

Transmission of a data byte, a 7-bit address, or either half of a 10-bit address is accomplished by simply writing a value to the SSPBUF register. This action will set the buffer full flag (BF) and allow the baud rate generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted (see data hold time spec). SCL is held low for one baud rate generator roll over count (TBRG). Data should be valid before SCL is released high (see data setup time spec). When the SCL pin is released high, it is held that way for TBRG, the data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDA. This allows the slave device being addressed to respond with an $\overline{ACK}$ bit during the ninth bit time. The status of $\overline{ACK}$ is read into the ACKDT on the rising edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge status bit (ACKSTAT) is cleared. Otherwise, the bit is set. The SSPIF is set on the falling edge of the ninth clock, and the master clock (baud rate generator) is suspended until the next data byte is loaded into the SSPBUF leaving SCL low and SDA unchanged (Figure 9-18).

A typical transmit sequence would go as follows:

a) The user generates a START Condition by setting the START enable bit (SEN) in SSPCON2.
b) SSPIF is set at the completion of the START sequence.
c) The user resets the SSPIF bit and loads the SSPBUF with seven bits of address plus R/$\overline{W}$ bit to transmit.
d) Address and R/$\overline{W}$ is shifted out the SDA pin until all eight bits are transmitted.
e) The MSSP Module shifts in the $\overline{ACK}$ bit from the slave device, and writes its value into the SSPCON2 register (SSPCON2<6>).
f) The module generates an interrupt at the end of the ninth clock cycle by setting SSPIF.
g) The user resets the SSPIF bit and loads the SSPBUF with eight bits of data.
h) DATA is shifted out the SDA pin until all eight bits are transmitted.
i) The MSSP Module shifts in the $\overline{ACK}$ bit from the slave device and writes its value into the SSPCON2 register (SSPCON2<6>).
j) The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
k) The user resets the SSPIF bit and generates a STOP condition by setting the STOP enable bit PEN in SSPCON2.
l) SSPIF is set when the STOP condition is complete.

9.2.12.1 BF STATUS FLAG

In Transmit mode, the BF bit (SSPSTAT<0>) is set when the CPU writes to SSPBUF and is cleared when all eight bits are shifted out.

9.2.12.2 WCOL STATUS FLAG

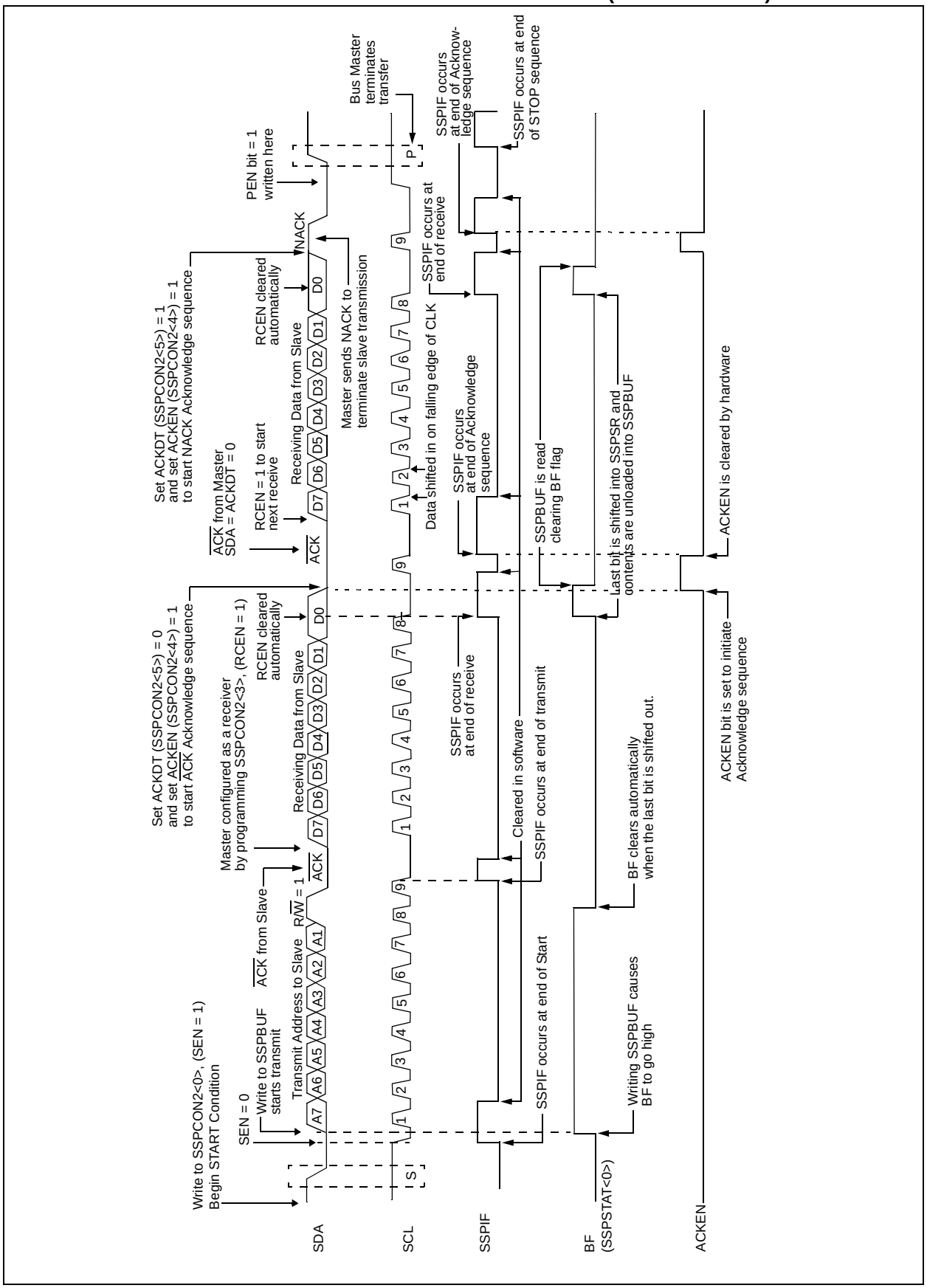
If the user writes the SSPBUF when a transmit is already in progress (i.e. SSPSR is still shifting out a data byte), then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

WCOL must be cleared in software.

9.2.12.3 ACKSTAT STATUS FLAG

In Transmit mode, the ACKSTAT bit (SSPCON2<6>) is cleared when the slave has sent an Acknowledge ($\overline{ACK}$ = 0), and is set when the slave does not Acknowledge ($\overline{ACK}$ = 1). A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

FIGURE 9-19: I²C MASTER WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)



After the A/D module has been configured as desired and the analog input channels have their corresponding TRIS bits selected for port inputs, the selected channel must be acquired before conversion is started. The A/D conversion cycle can be initiated by setting the GO/$\overline{\text{DONE}}$ bit. The A/D conversion begins and lasts for 13TAD. The following steps should be followed for performing an A/D conversion:

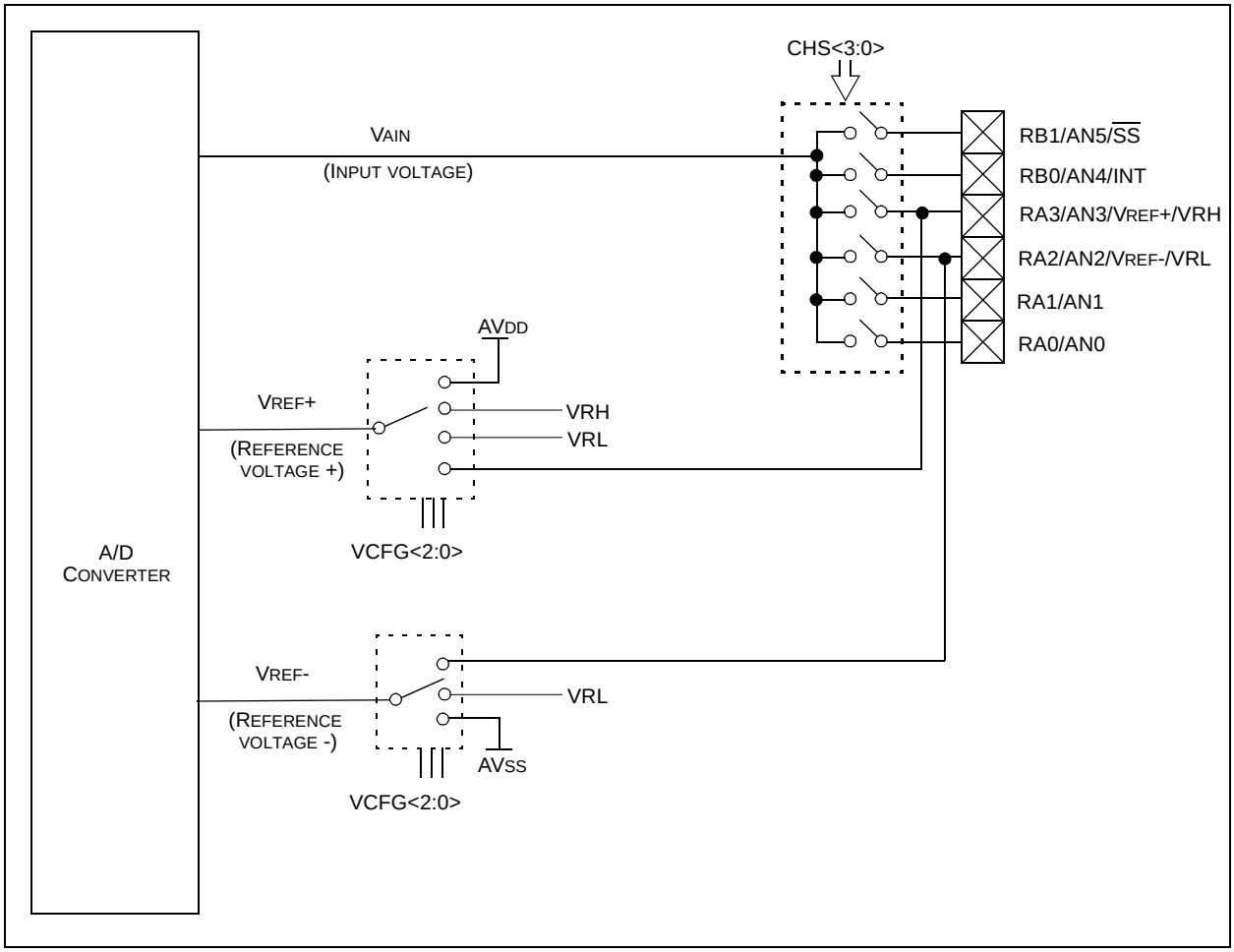
1. Configure port pins:
   - Configure Analog Input mode (ANSEL)
   - Configure pin as input (TRISA or TRISB)
2. Configure the A/D module
   - Configure A/D Result Format / voltage reference (ADCON1)
   - Select A/D input channel (ADCON0)
   - Select A/D conversion clock (ADCON0)
   - Turn on A/D module (ADCON0)
3. Configure A/D interrupt (if required)
   - Clear ADIF bit
   - Set ADIE bit
   - Set PEIE bit
   - Set GIE bit
4. Wait the required acquisition time.
5. START conversion
   - Set GO/$\overline{\text{DONE}}$ bit (ADCON0)
6. Wait 13TAD until A/D conversion is complete, by either:
   - Polling for the GO/$\overline{\text{DONE}}$ bit to be cleared

   OR
   - Waiting for the A/D interrupt
7. Read A/D Result registers (ADRESH and ADRESL), clear ADIF if required.
8. For next conversion, go to step 1, step 2 or step 3 as required.

Clearing the GO/$\overline{\text{DONE}}$ bit during a conversion will abort the current conversion. The ADRESH and ADRESL registers will be updated with the partially completed A/D conversion value. That is, the ADRESH and ADRESL registers will contain the value of the current incomplete conversion.

Note:	Do not set the ADON bit and the GO/$\overline{\text{DONE}}$ bit in the same instruction. Doing so will cause the GO/$\overline{\text{DONE}}$ bit to be automatically cleared.

FIGURE 11-3: A/D BLOCK DIAGRAM



12.2 Oscillator Configurations

12.2.1 OSCILLATOR TYPES

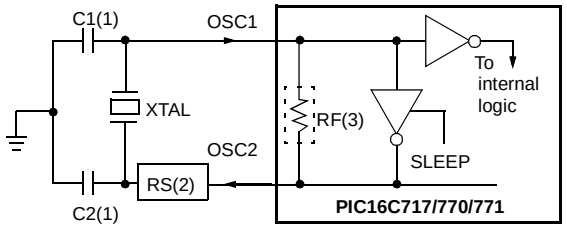
The PIC16C717/770/771 can be operated in eight different Oscillator modes. The user can program three configuration bits (FOSC<2:0>) to select one of these eight modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- ER External Resistor (with and without CLKOUT)
- INTRC Internal 4 MHz (with and without CLKOUT)
- EC External Clock

12.2.2 LP, XT AND HS MODES

In LP, XT or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 12-1). The PIC16C717/770/771 oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications.

FIGURE 12-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)



Note1: See Table 12-1 and Table 12-2 for recommended values of C1 and C2.
2: A series resistor (RS) may be required for AT strip cut crystals.
3: RF varies with the Crystal mode chosen.

TABLE 12-1: CERAMIC RESONATORS

Ranges Tested:			
Mode	**Freq**	**OSC1**	**OSC2**
XT	455 kHz 2.0 MHz 4.0 MHz	68 - 100 pF 15 - 68 pF 15 - 68 pF	68 - 100 pF 15 - 68 pF 15 - 68 pF
HS	8.0 MHz 16.0 MHz	10 - 68 pF 10 - 22 pF	10 - 68 pF 10 - 22 pF
These values are for design guidance only. See notes at bottom of page.			
All resonators used did not have built-in capacitors.			

TABLE 12-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

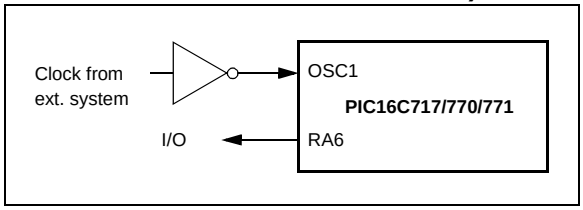
Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
These values are for design guidance only. See notes at bottom of page.			

Note 1: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
2: Higher capacitance increases the stability of oscillator but also increases the start-up time.

12.2.3 EC MODE

In applications where the clock source is external, the PIC16C717/770/771 should be programmed to select the EC (External Clock) mode. In this mode, the RA6/OSC2/CLKOUT pin is available as an I/O pin. See Figure 12-2 for illustration.

FIGURE 12-2: EXTERNAL CLOCK INPUT OPERATION (EC OSC CONFIGURATION)



12.10 Interrupts

The devices have up to 11 sources of interrupt. The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note:	Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

A Global Interrupt Enable bit, GIE (INTCON<7>), enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled and an interrupt's flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in various registers. Individual interrupt bits are set, regardless of the status of the GIE bit. The GIE bit is cleared on RESET.

The "return from interrupt" instruction, `RETFIE`, exits the interrupt routine as well as sets the GIE bit, which re-enables interrupts.

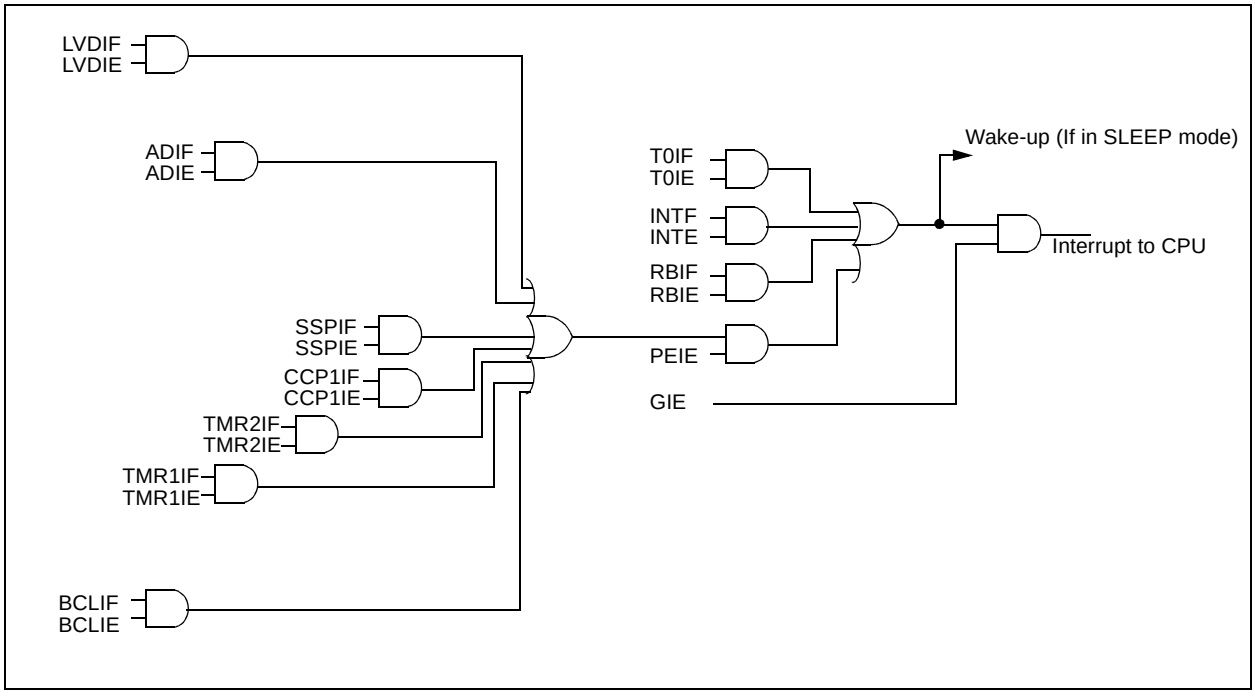
The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flags are contained in the special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2, and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, the GIE bit is cleared to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs. The latency is the same for one or two cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit

FIGURE 12-10: INTERRUPT LOGIC



15.5 Master SSP SPI Mode Timing Waveforms and Requirements

FIGURE 15-18: SPI MASTER MODE TIMING (CKE = 0)

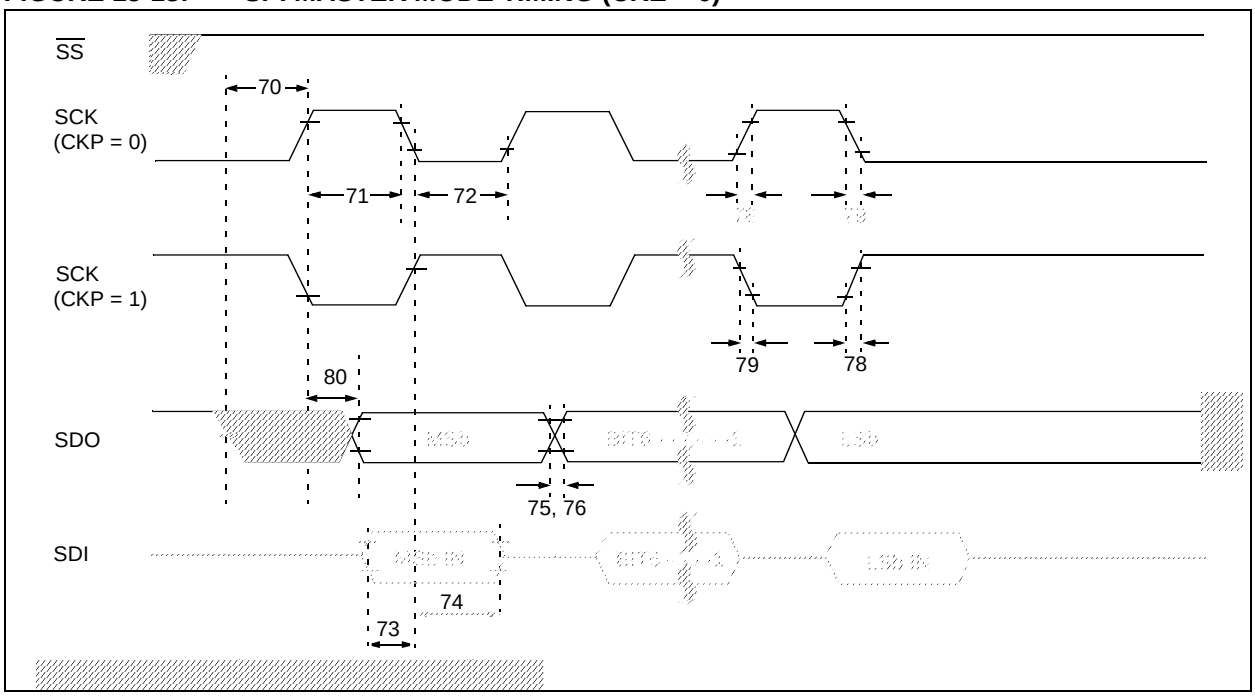


TABLE 15-17: SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}$↓ to SCK↓ or SCK↑ input		TCY	—	—	ns	
71*	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A*			Single Byte	40	—	—	ns	**Note 1**
72*	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A*			Single Byte	40	—	—	ns	**Note 1**
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A*	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**Note 1**
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75*	TdoR	SDO data output rise time	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX	—	20	45	ns	
76*	TdoF	SDO data output fall time		—	10	25	ns	
78*	TscR	SCK output rise time (Master mode)	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX	—	20	45	ns	
79*	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC16**C**XXX	—	—	50	ns	
			PIC16**LC**XXX	—	—	100	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 16-18: MAXIMUM I_{PD} VS. V_{DD} (-40°C TO +125°C)

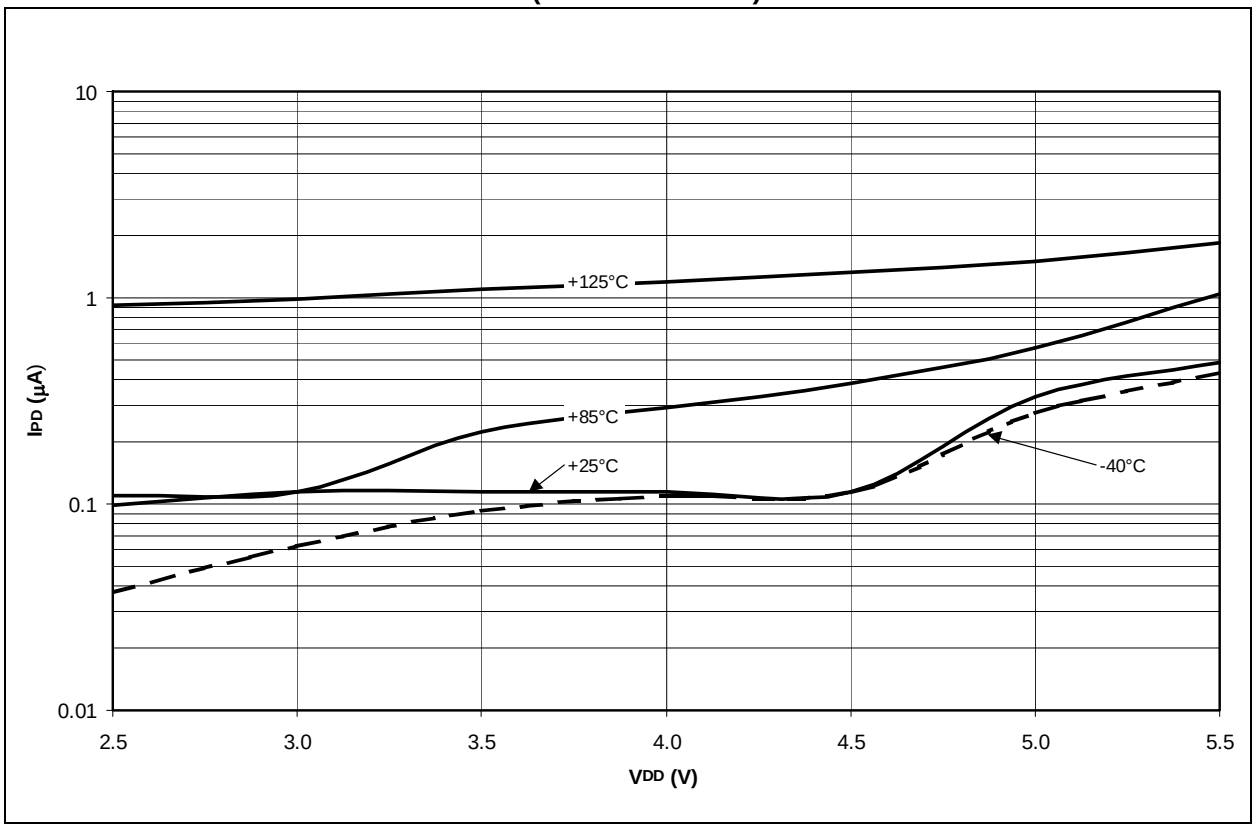


FIGURE 16-22: TYPICAL AND MAXIMUM ΔIVRH VS. VDD (-40°C TO +125°C)

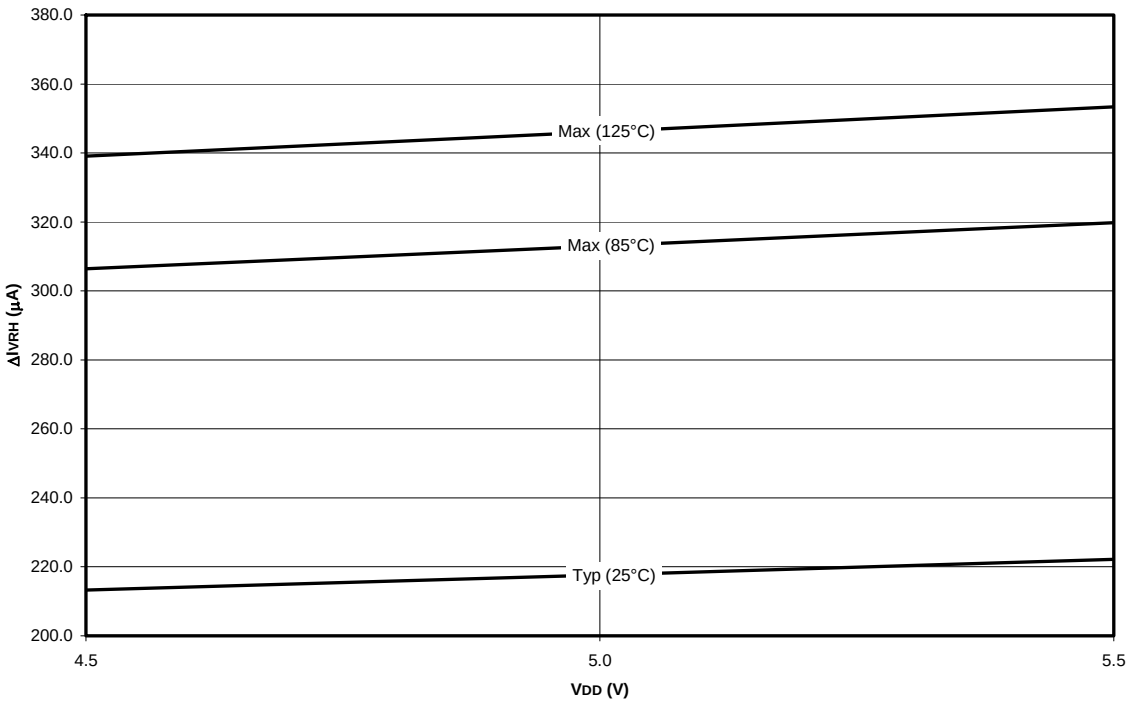


FIGURE 16-23: TYPICAL AND MAXIMUM ΔILVD VS. VDD (-40°C TO +125°C) (LVD TRIP = 3.0V)

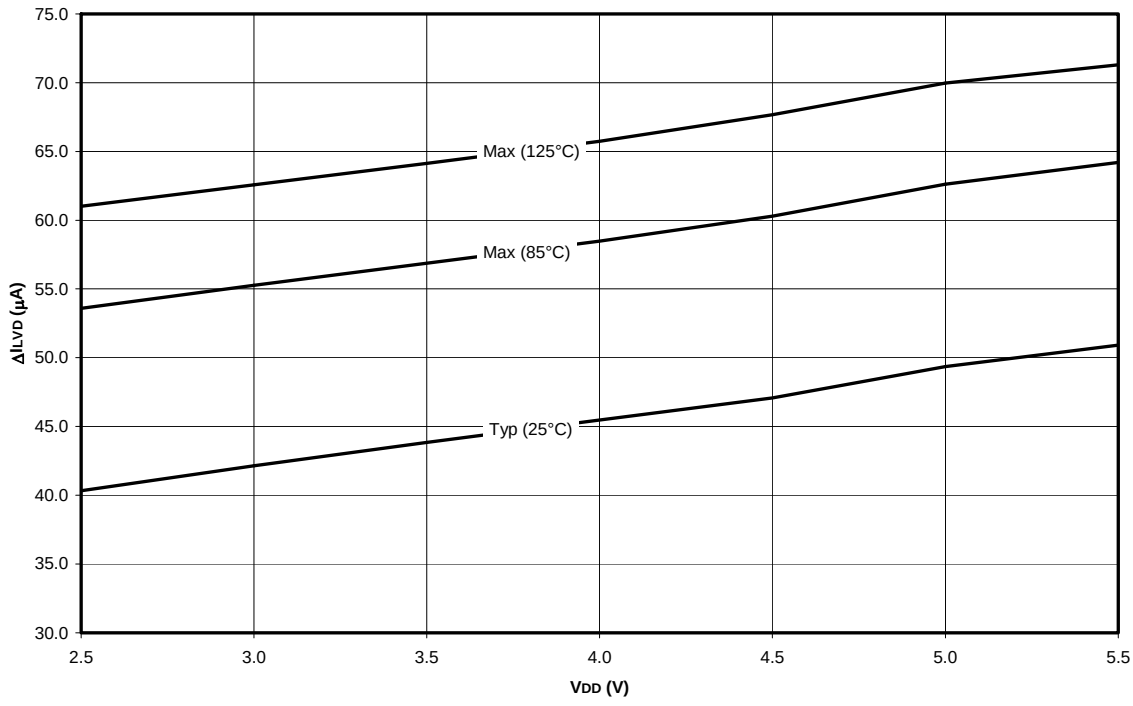


FIGURE 16-24: TYPICAL AND MAXIMUM ΔILVD VS. VDD (-40°C TO +125°C) (LVD TRIP = 4.5V)

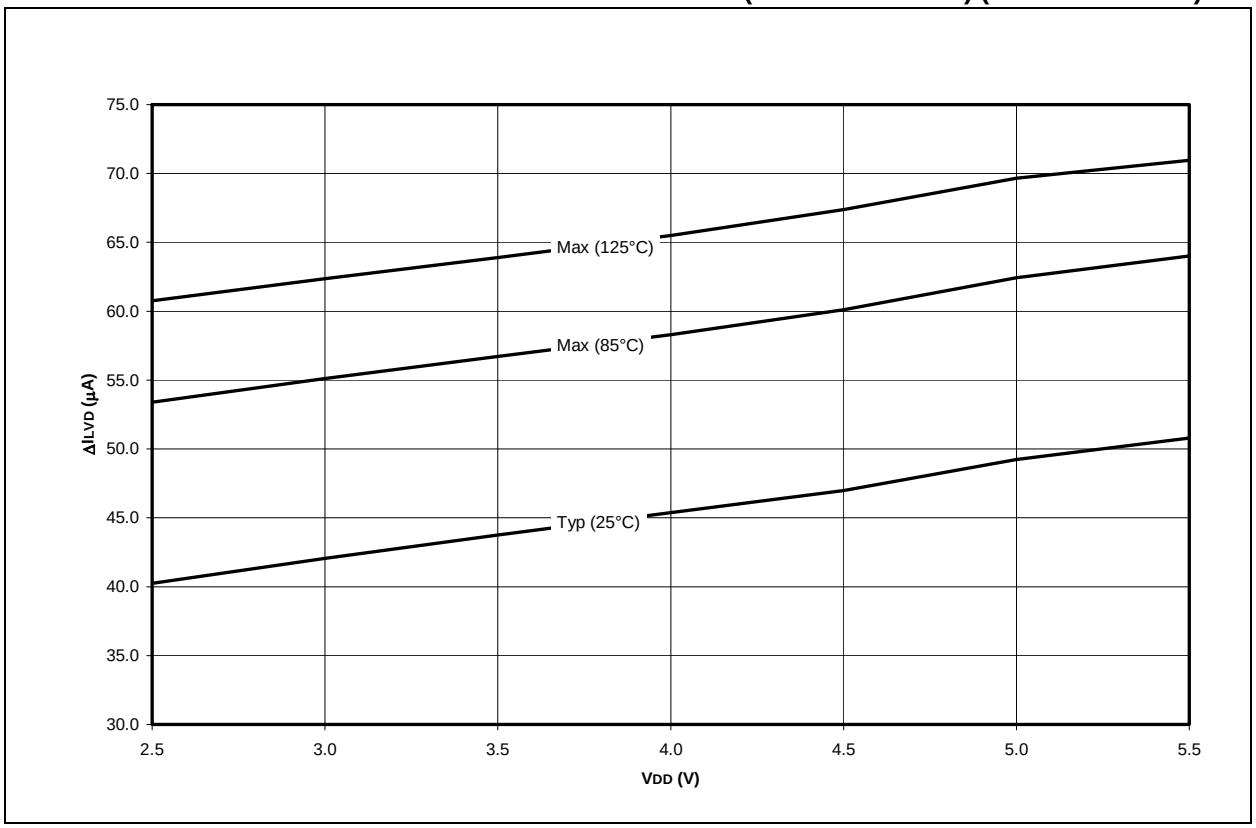


FIGURE 16-25: TYPICAL AND MAXIMUM ΔIBOR VS. VDD (-40°C TO +125°C) (VBOR = 2.5V)

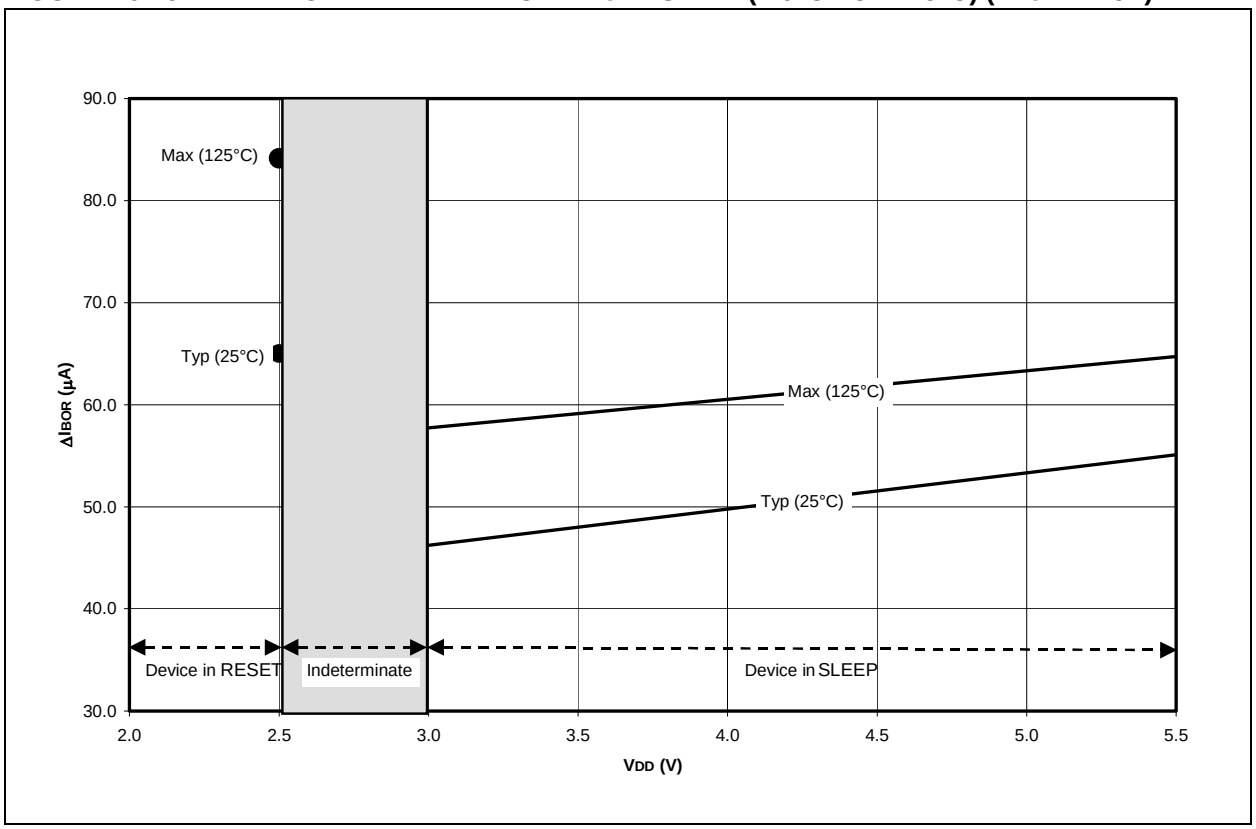


FIGURE 16-30: VOH VS. IOH (-40°C TO +125°C, VDD = 5.0V)

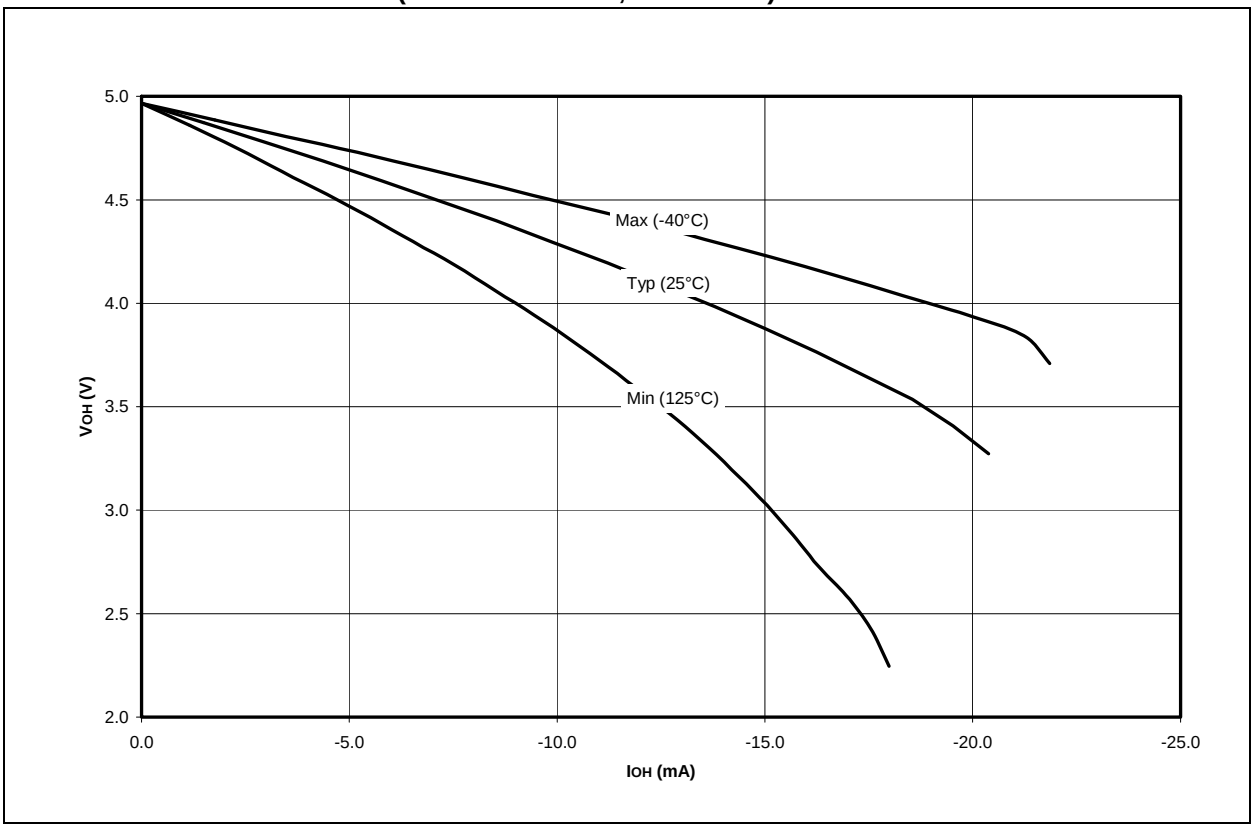
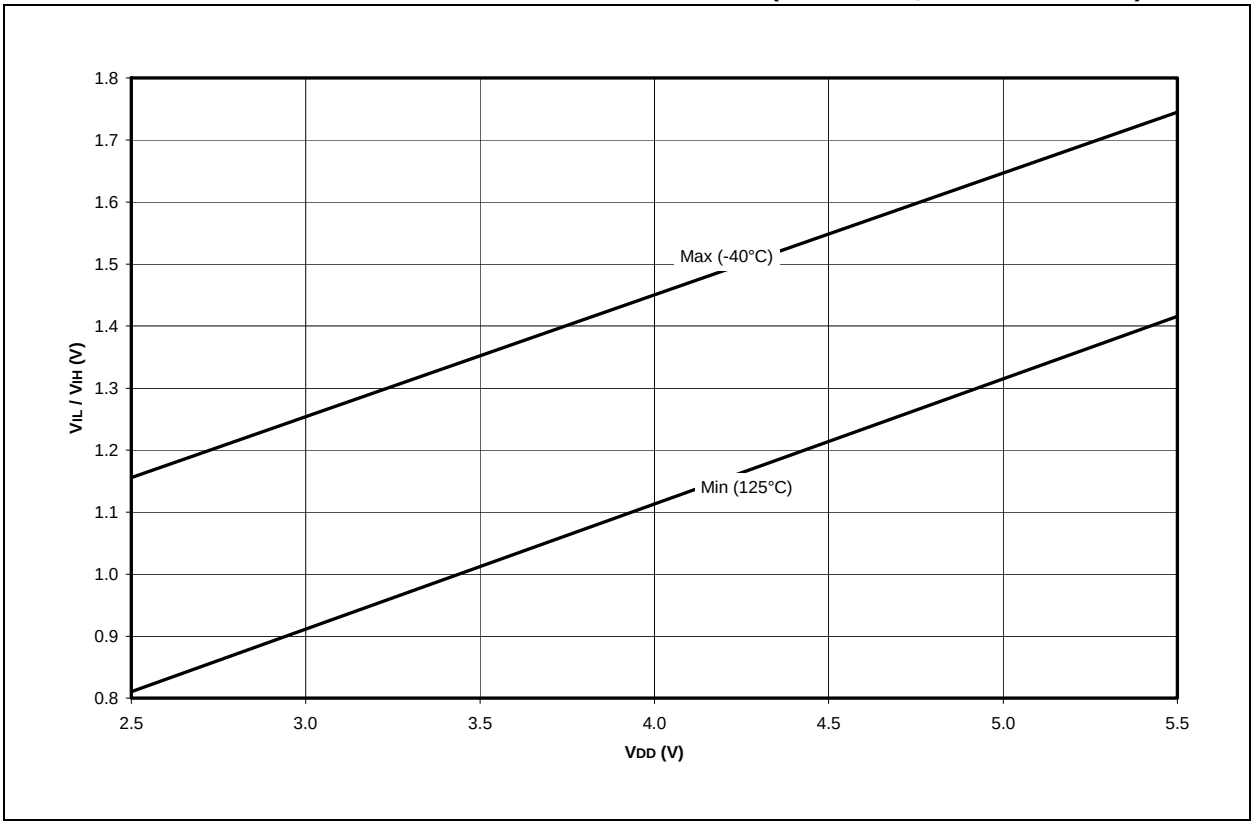


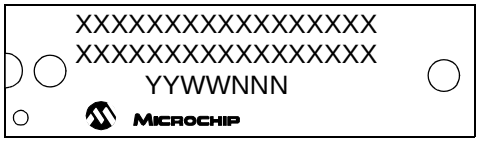
FIGURE 16-31: MINIMUM AND MAXIMUM VIH/VIL VS. VDD (TTL INPUT,-40°C TO +125°C)



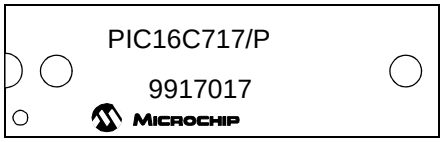
17.0 PACKAGING INFORMATION

17.1 Package Marking Information

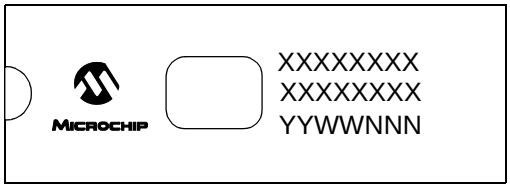
18-Lead PDIP



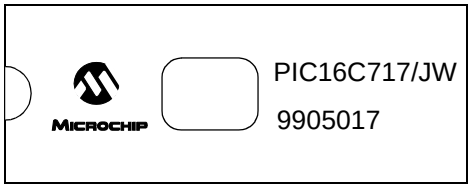
Example



18-Lead CERDIP Windowed



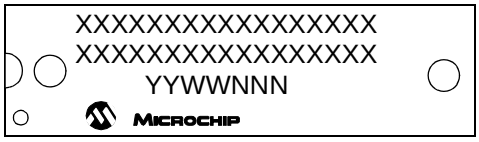
Example



18-Lead SOIC

Example

20-Lead PDIP



Example

Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

17.6 20-Lead Ceramic Dual In-line with Window (JW) – 300 mil (CERDIP)

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